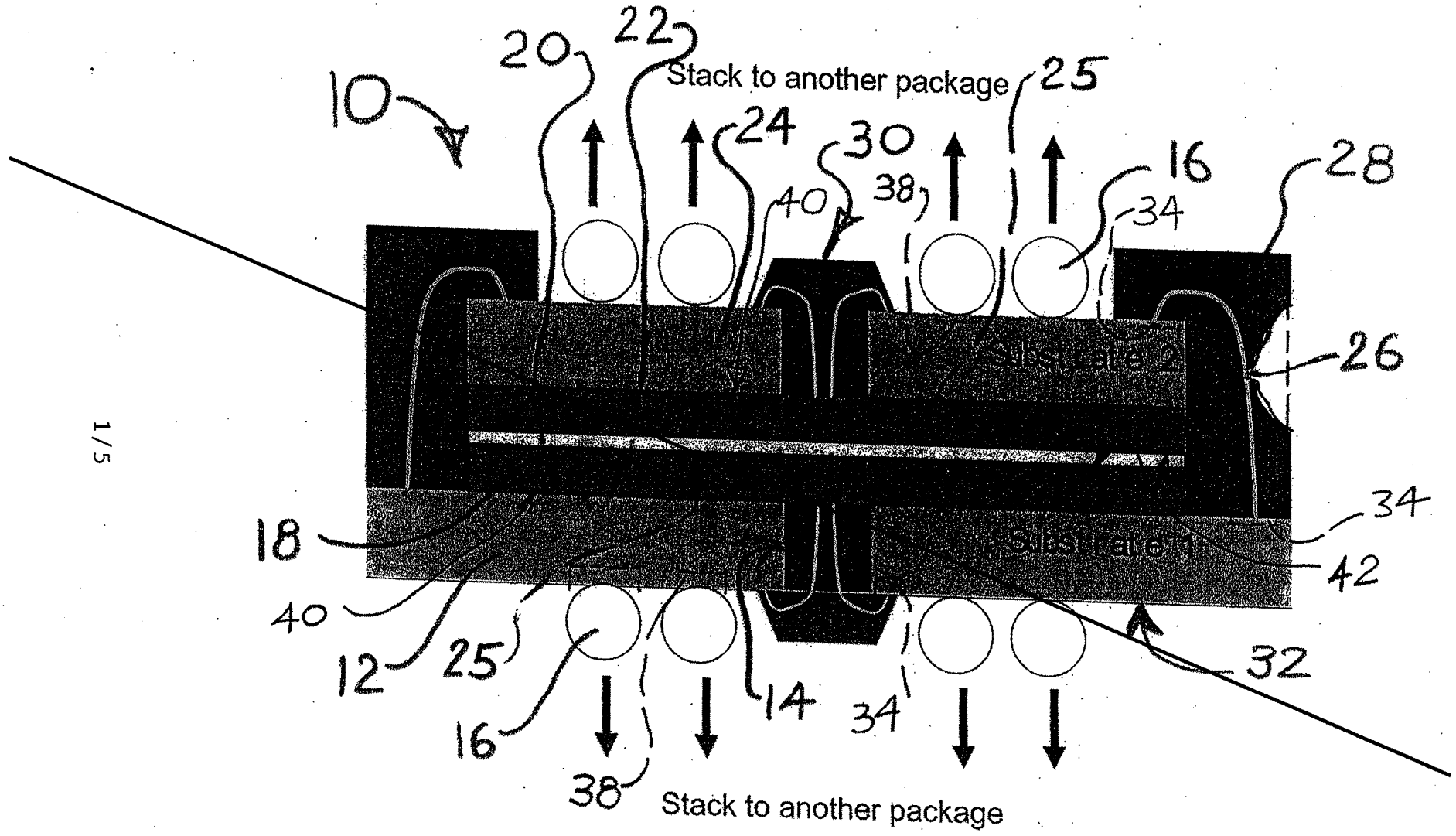

10
20
22
Stack to another package
25
24
30
40
38
16
28
34
26
Substrate 2
18
34
Substrate 1
42
40
12
25
32
14
34
16
38
Stack to another package

FIG. 1

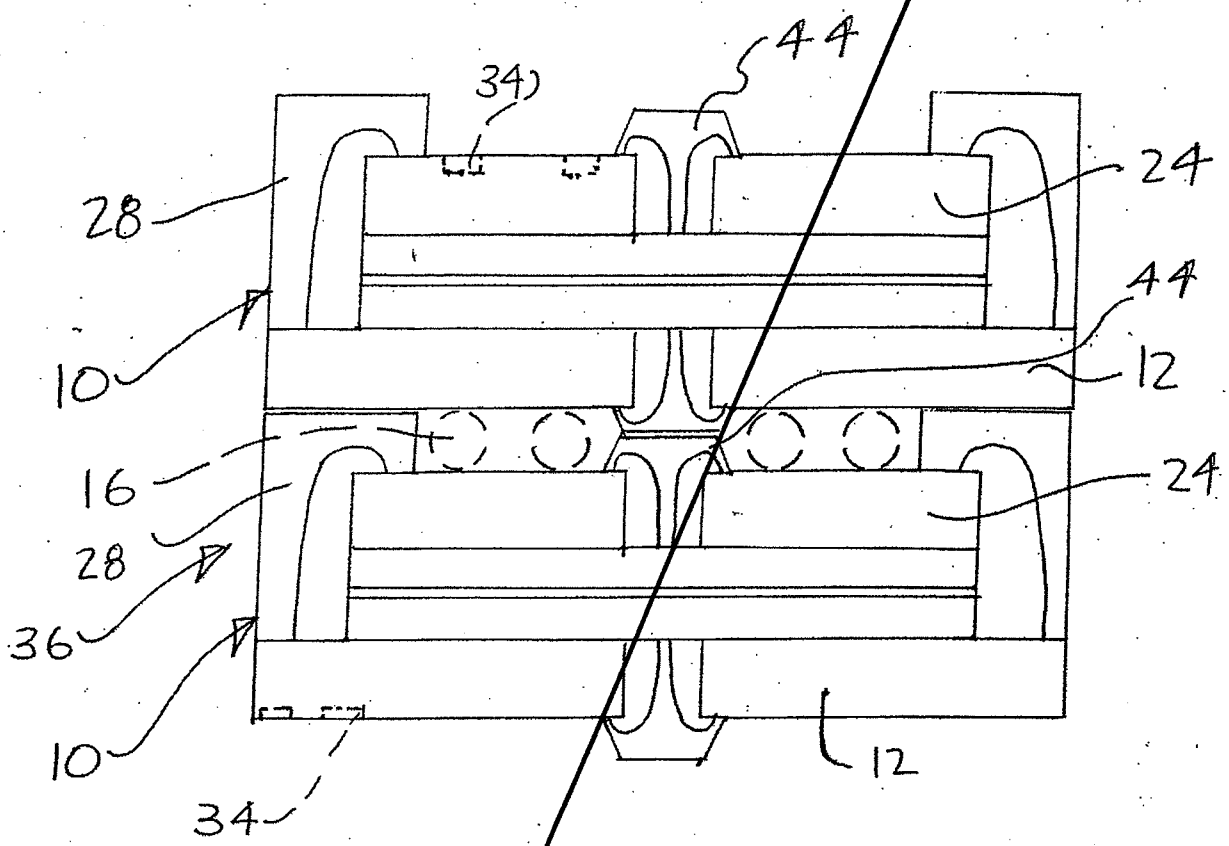


FIG. 2

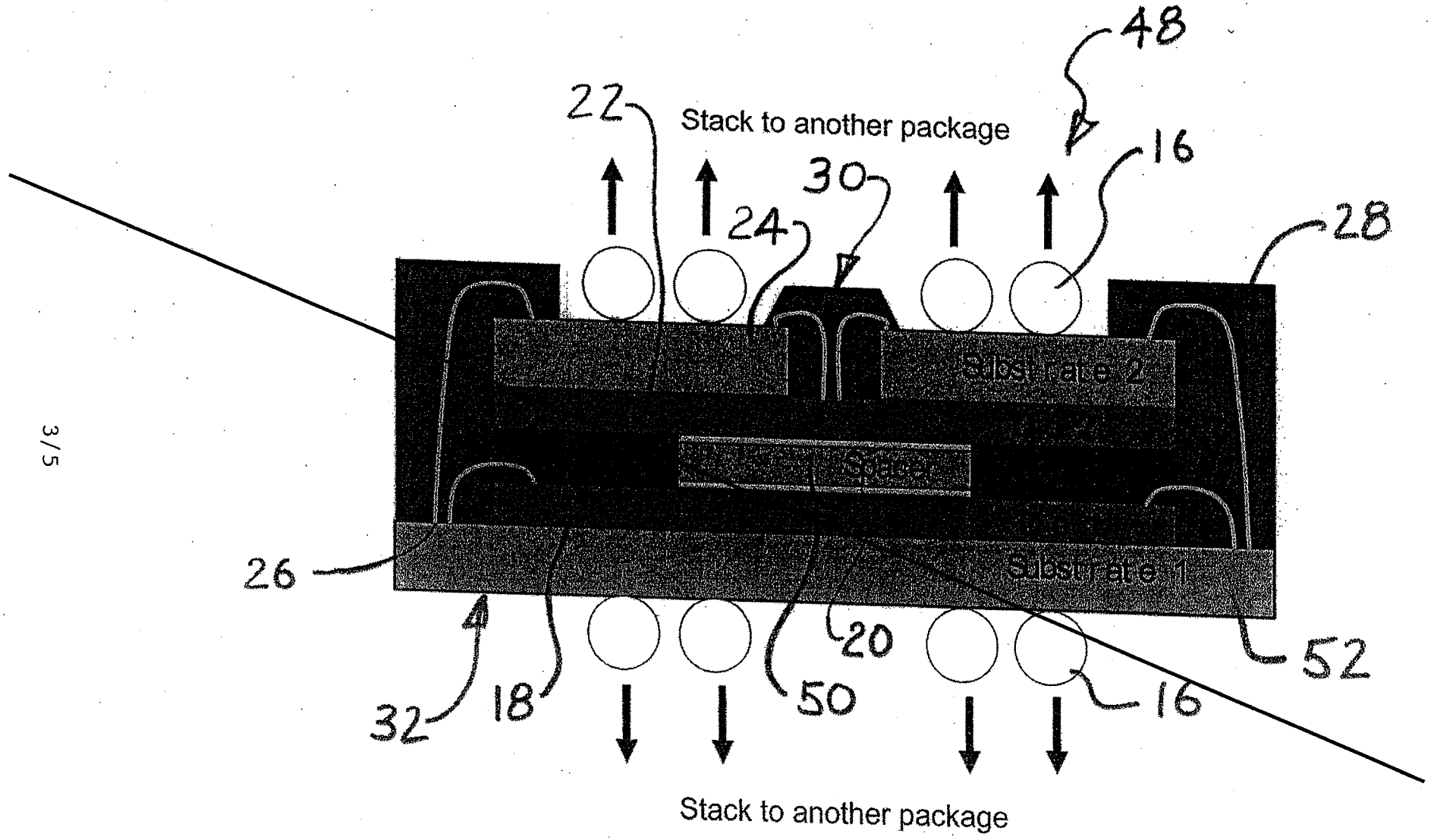

48
22
Stack to another package
16
30
24
28
Substrate 2
Spacer
26
Substrate 1
20
52
32
18
50
16
Stack to another package

FIG. 3

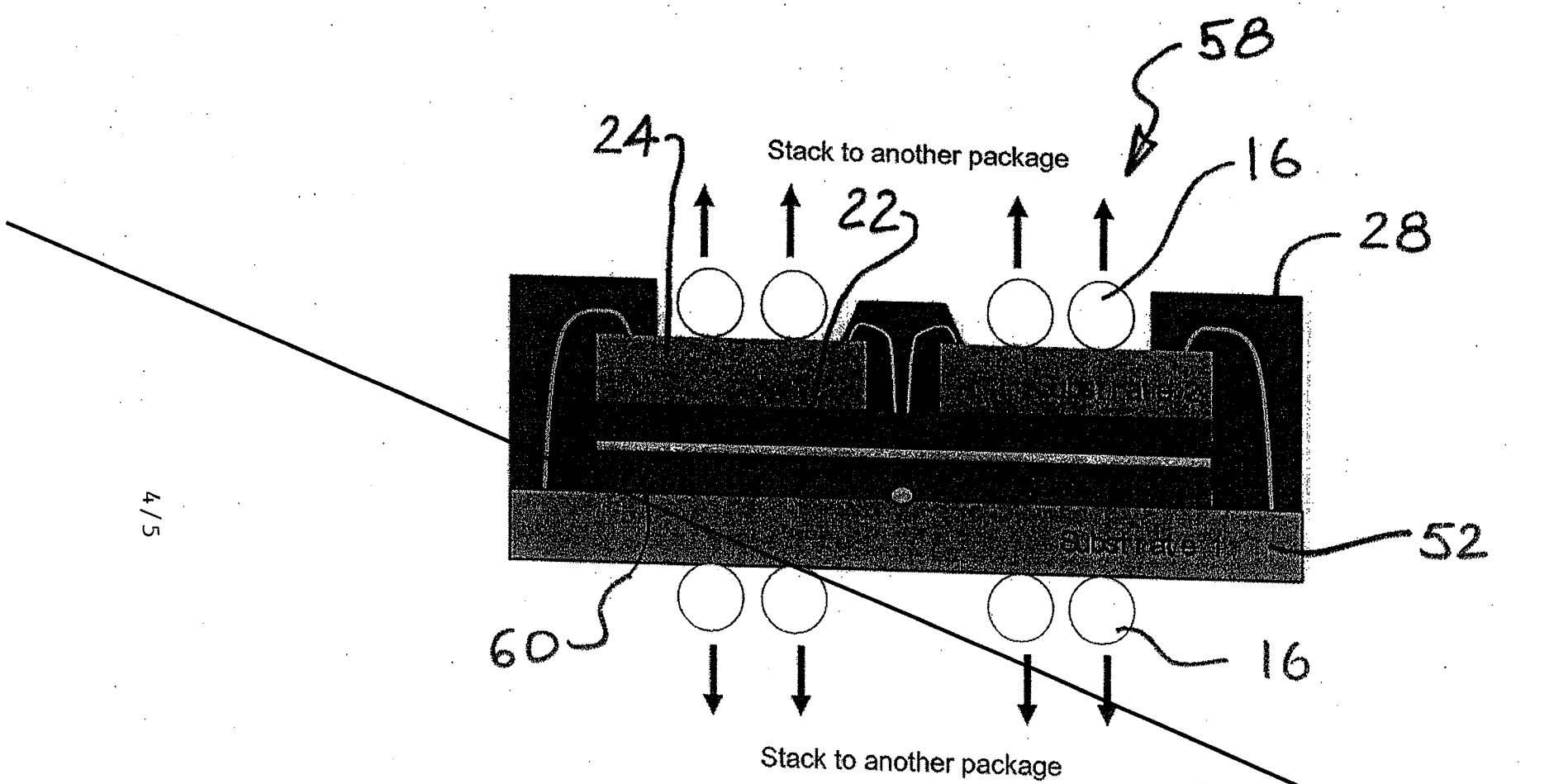

58
24
Stack to another package
16
22
28
52
60
16
Stack to another package

FIG. 4

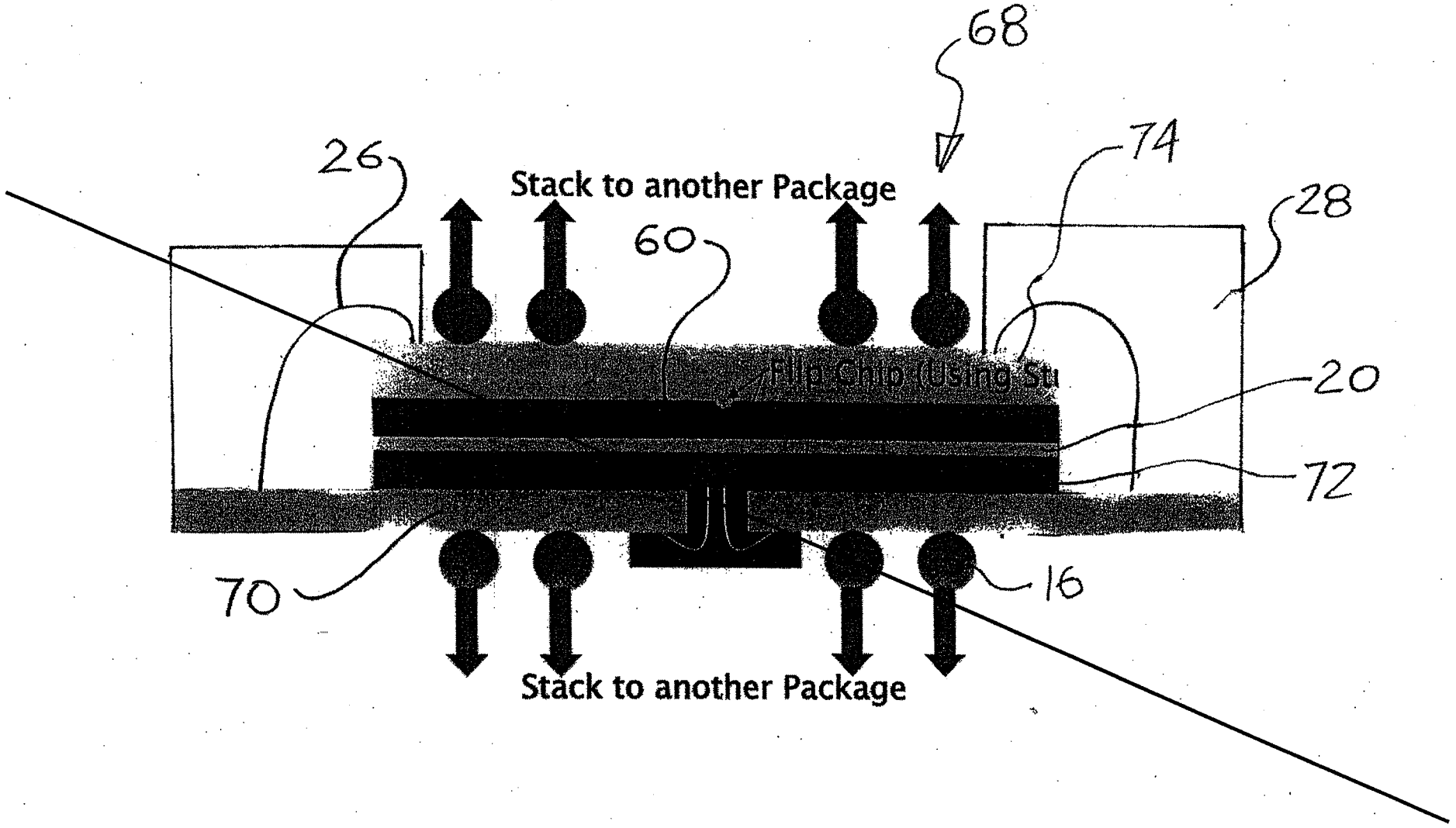

68
26
Stack to another Package
74
28
60
Flip Chip (Using Stu
20
72
70
16
Stack to another Package

FIG. 5

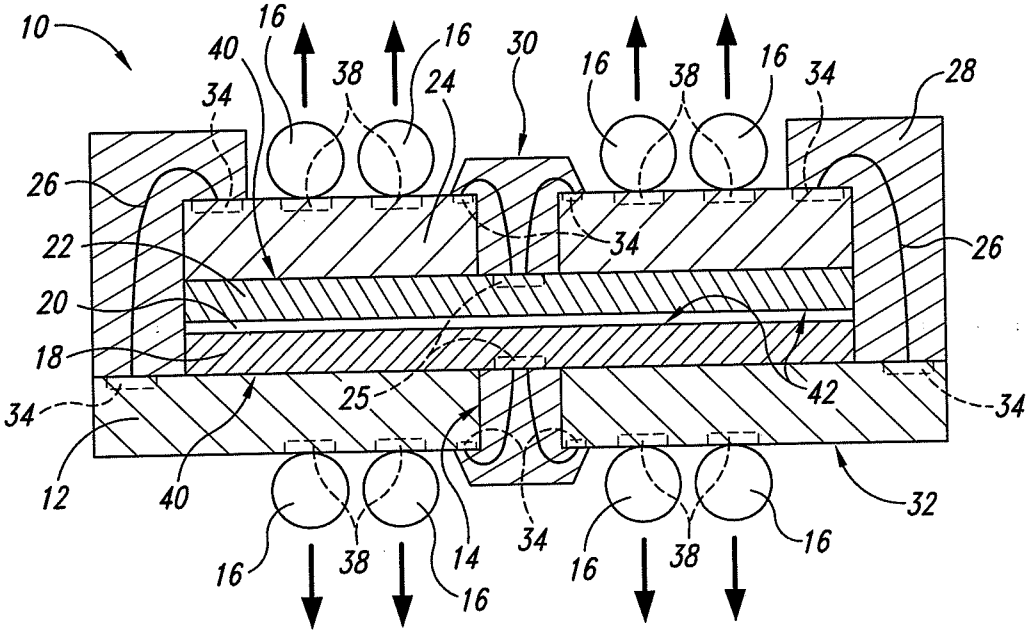

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16

Fig. 1

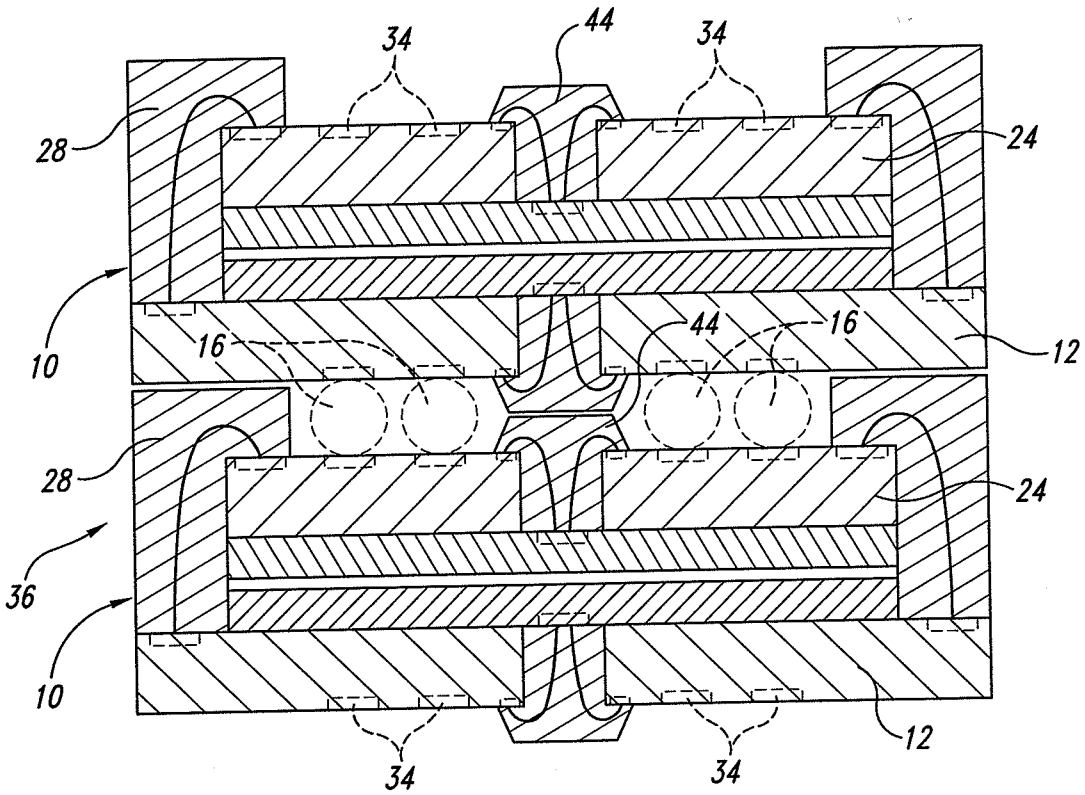

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44
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34
34

Fig. 2

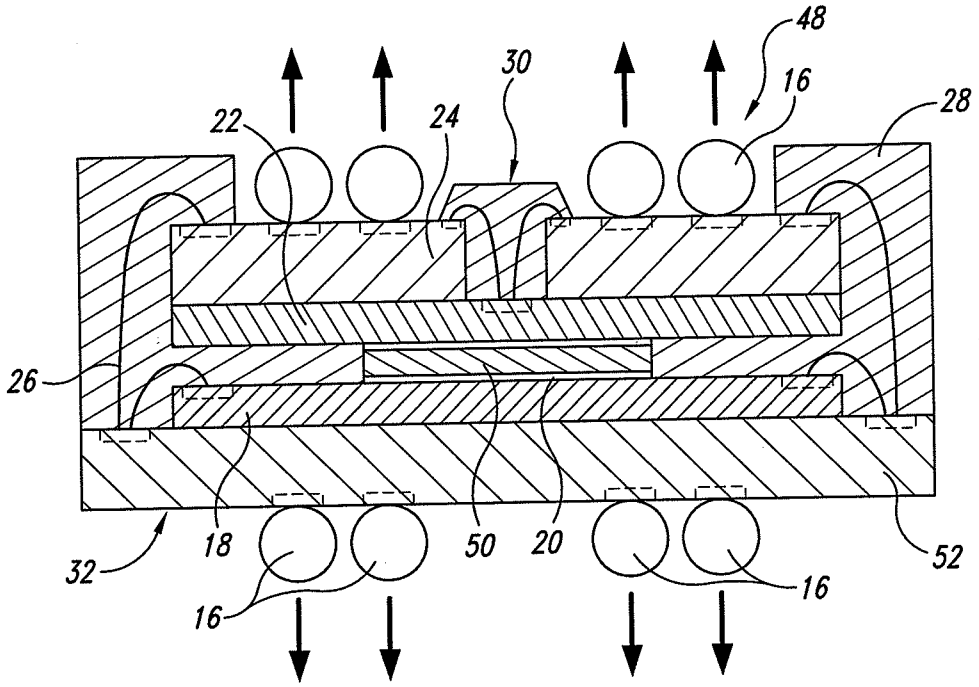


Fig. 3

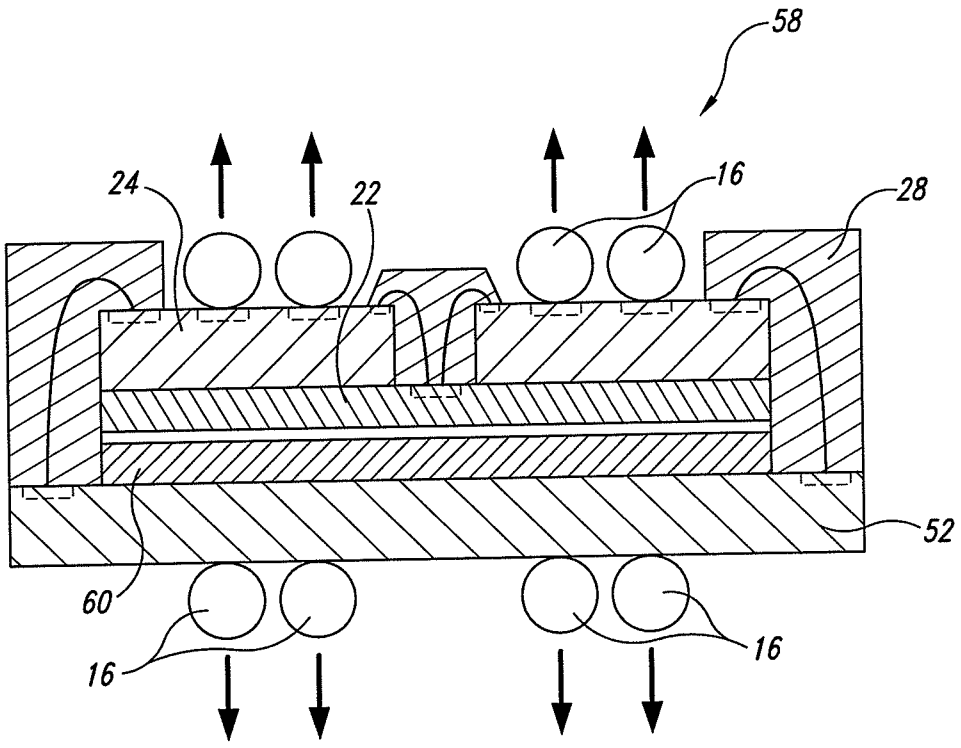


Fig. 4

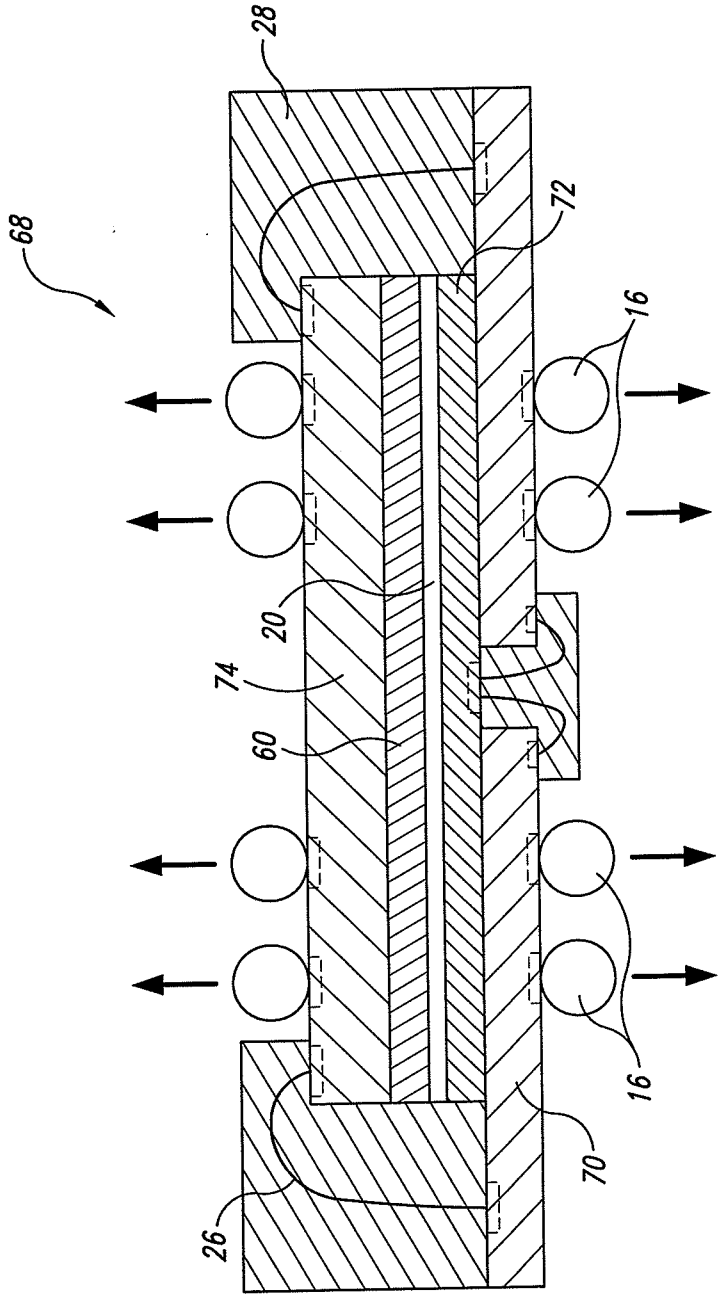


Fig. 5